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June 2014

# FDB024N04AL7

## N-Channel PowerTrench<sup>®</sup> MOSFET

40 V, 219 A, 2.4 mΩ

### Features

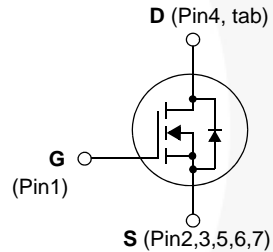
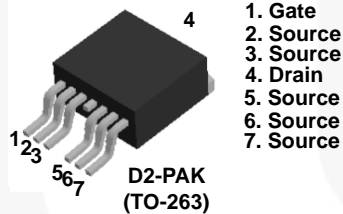
- $R_{DS(on)} = 2.0 \text{ m}\Omega$  (Typ.) @  $V_{GS} = 10 \text{ V}$ ,  $I_D = 80 \text{ A}$
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low  $R_{DS(on)}$
- High Power and Current Handling Capability
- RoHS Compliant

### Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

### Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies



### MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol         | Parameter  | FDB024N04AL7  | Unit             |
|----------------|--|---|------------------|
| $V_{DSS}$      | Drain to Source Voltage  | 40  | V                |
| $V_{GSS}$      | Gate to Source Voltage   | $\pm 20$  | V                |
| $I_D$          | Drain Current  | - Continuous ( $T_C = 25^\circ\text{C}$ , Silicon Limited)  | 219*             |
|                |  | - Continuous ( $T_C = 100^\circ\text{C}$ , Silicon Limited) | 155*             |
|                |  | - Continuous ( $T_C = 25^\circ\text{C}$ , Package Limited)  | 100              |
| $I_{DM}$       | Drain Current  | - Pulsed (Note 1)   | 876              |
| $E_{AS}$       | Single Pulsed Avalanche Energy                                       | (Note 2)  | 864              |
| dv/dt          | Peak Diode Recovery dv/dt  | (Note 3)  | 6.0              |
| $P_D$          | Power Dissipation  | ( $T_C = 25^\circ\text{C}$ )                                | 214              |
|                |  | - Derate Above $25^\circ\text{C}$                           | 1.43             |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                              | -55 to +175   | $^\circ\text{C}$ |
| $T_L$          | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | 300   | $^\circ\text{C}$ |

\*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 100 A.

### Thermal Characteristics

| Symbol          | Parameter                                     | FDB024N04AL7 | Unit                      |
|-----------------|---|--------------|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max.    | 0.7          | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5         |                           |

## Package Marking and Ordering Information

| Part Number  | Top Mark   | Package  | Packing Method | Reel Size | Tape Width | Quantity  |
|--------------|------------|----------|----------------|-----------|------------|-----------|
| FDB024N04AL7 | FDB024N04A | D2PAK-7L | Tape and Reel  | 330 mm    | 24 mm      | 800 units |

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|-----------------|------|------|------|------|
|--------|-----------|-----------------|------|------|------|------|

### Off Characteristics

|                                      |   |   |    |    |           |                            |
|--------------------------------------|---|---|----|----|-----------|----------------------------|
| $BV_{DSS}$                           | Drain to Source Breakdown Voltage         | $I_D = 250 \mu\text{A}$ , $V_{GS} = 0 \text{ V}$ , $T_C = 25^\circ\text{C}$ | 40 | -  | -         | V                          |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$                  | -  | 30 | -         | $\text{mV}/^\circ\text{C}$ |
| $I_{DSS}$                            | Zero Gate Voltage Drain Current           | $V_{DS} = 32 \text{ V}$ , $V_{GS} = 0 \text{ V}$                            | -  | -  | 10        | $\mu\text{A}$              |
|                                      |   | $V_{DS} = 32 \text{ V}$ , $T_C = 150^\circ\text{C}$                         | -  | -  | 500       |                            |
| $I_{GSS}$                            | Gate to Body Leakage Current              | $V_{GS} = \pm 20 \text{ V}$ , $V_{DS} = 0 \text{ V}$                        | -  | -  | $\pm 100$ | nA                         |

### On Characteristics

|              |                                      |  |     |     |     |                  |
|--------------|--------------------------------------|--|-----|-----|-----|------------------|
| $V_{GS(th)}$ | Gate Threshold Voltage               | $V_{GS} = V_{DS}$ , $I_D = 250 \mu\text{A}$    | 1.0 | -   | 3.0 | V                |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS} = 10 \text{ V}$ , $I_D = 80 \text{ A}$ | -   | 2.0 | 2.4 | $\text{m}\Omega$ |
| $g_{FS}$     | Forward Transconductance             | $V_{DS} = 10 \text{ V}$ , $I_D = 80 \text{ A}$ | -   | 368 | -   | S                |

### Dynamic Characteristics

|              |                                  |   |          |      |      |    |
|--------------|----------------------------------|---|----------|------|------|----|
| $C_{iss}$    | Input Capacitance                | $V_{DS} = 25 \text{ V}$ , $V_{GS} = 0 \text{ V}$ ,<br>$f = 1 \text{ MHz}$   | -        | 5490 | 7300 | pF |
| $C_{oss}$    | Output Capacitance               |   | -        | 1220 | 1620 | pF |
| $C_{rss}$    | Reverse Transfer Capacitance     |   | -        | 155  | 233  | pF |
| $Q_{g(tot)}$ | Total Gate Charge at 10V         | $V_{DS} = 32 \text{ V}$ , $I_D = 80 \text{ A}$ ,<br>$V_{GS} = 10 \text{ V}$ | -        | 84   | 109  | nC |
| $Q_{gs}$     | Gate to Source Gate Charge       |   | -        | 19   | -    | nC |
| $Q_{gs2}$    | Gate Charge Threshold to Plateau |   | -        | 9.5  | -    | nC |
| $Q_{gd}$     | Gate to Drain "Miller" Charge    |   | (Note 4) | -    | 12   | -  |

### Switching Characteristics

|              |                                    |  |          |     |     |          |
|--------------|------------------------------------|--|----------|-----|-----|----------|
| $t_{d(on)}$  | Turn-On Delay Time                 | $V_{DD} = 20 \text{ V}$ , $I_D = 80 \text{ A}$ ,<br>$R_G = 4.7 \Omega$ , $V_{GS} = 10 \text{ V}$ | -        | 17  | 44  | ns       |
| $t_r$        | Turn-On Rise Time                  |  | -        | 8   | 26  | ns       |
| $t_{d(off)}$ | Turn-Off Delay Time                |  | -        | 71  | 152 | ns       |
| $t_f$        | Turn-Off Fall Time                 |  | (Note 4) | -   | 17  | 44       |
| ESR          | Equivalent Series Resistance (G-S) | $f = 1 \text{ MHz}$  | -        | 1.1 | -   | $\Omega$ |

### Drain-Source Diode Characteristics

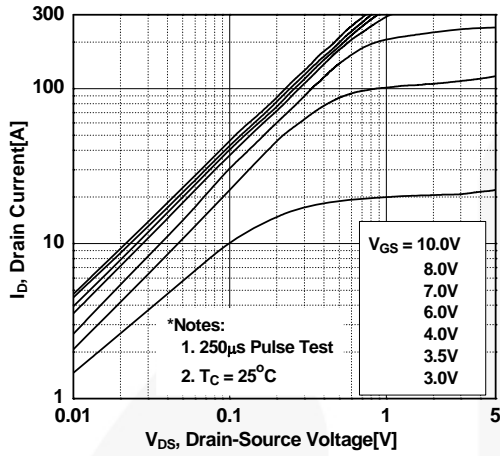
|          |  |  |   |     |     |    |
|----------|--|--|---|-----|-----|----|
| $I_S$    | Maximum Continuous Drain to Source Diode Forward Current | -  | - | 219 | A   |    |
| $I_{SM}$ | Maximum Pulsed Drain to Source Diode Forward Current     | -  | - | 876 | A   |    |
| $V_{SD}$ | Drain to Source Diode Forward Voltage                    | $V_{GS} = 0 \text{ V}$ , $I_{SD} = 80 \text{ A}$   | - | -   | 1.3 | V  |
| $t_{rr}$ | Reverse Recovery Time                                    | $V_{GS} = 0 \text{ V}$ , $I_{SD} = 80 \text{ A}$ , | - | 54  | -   | ns |
| $Q_{rr}$ | Reverse Recovery Charge                                  | $di_F/dt = 100 \text{ A}/\mu\text{s}$              | - | 49  | -   | nC |

#### Notes:

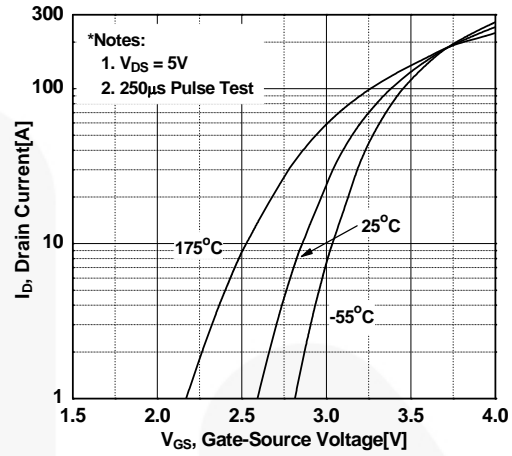
1. Repetitive rating: pulse-width limited by maximum junction temperature.
2.  $L = 3 \text{ mH}$ ,  $I_{AS} = 24 \text{ A}$ ,  $V_{DD} = 40 \text{ V}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 80 \text{ A}$ ,  $di/dt \leq 200 \text{ A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature typical characteristics.

## Typical Performance Characteristics

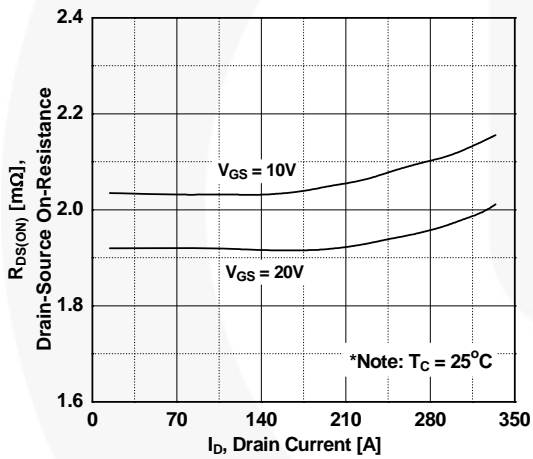
**Figure 1. On-Region Characteristics**



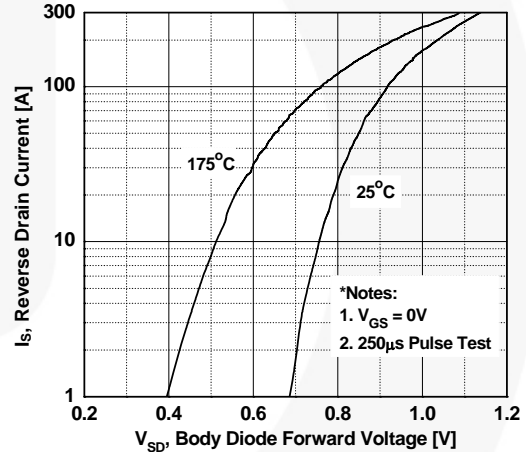
**Figure 2. Transfer Characteristics**



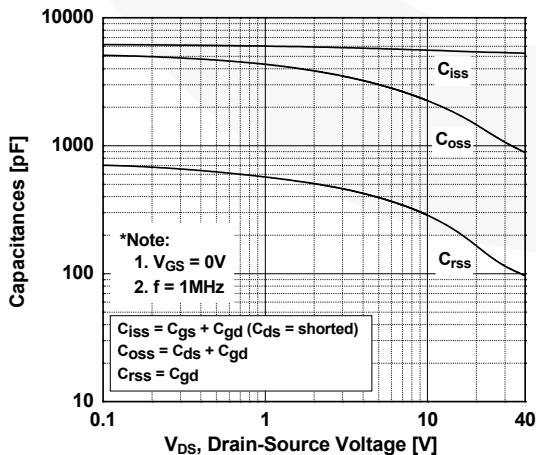
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



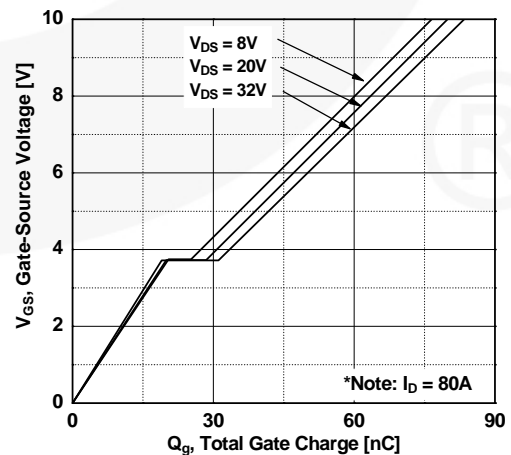
**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**



**Figure 5. Capacitance Characteristics**

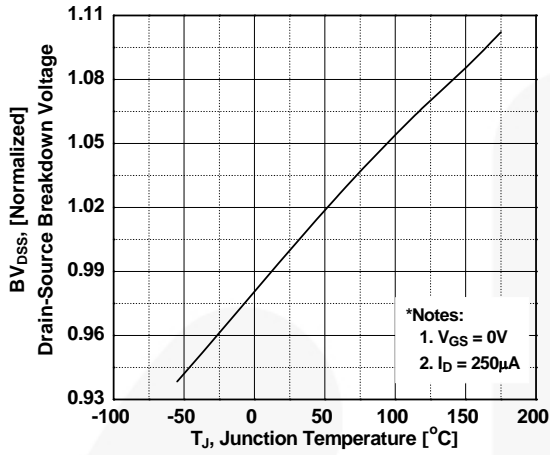


**Figure 6. Gate Charge Characteristics**

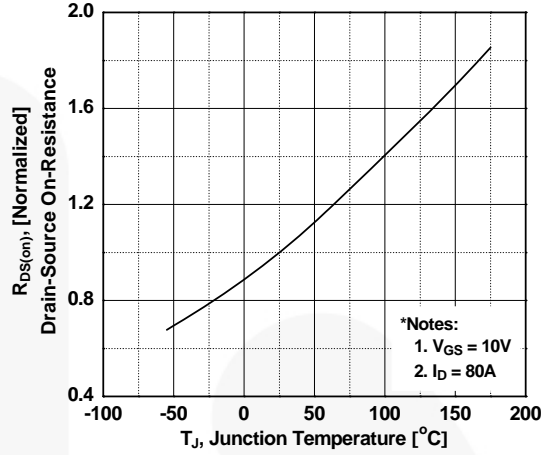


## Typical Performance Characteristics (Continued)

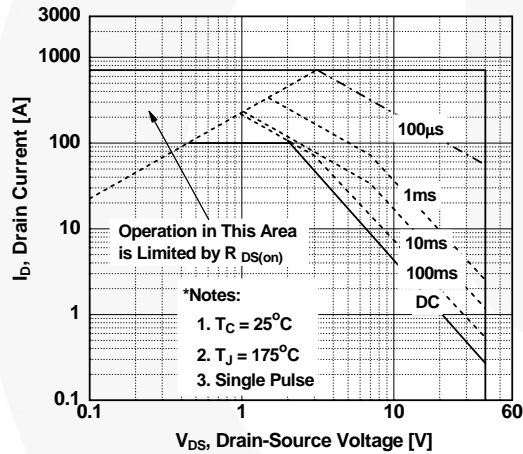
**Figure 7. Breakdown Voltage Variation vs. Temperature**



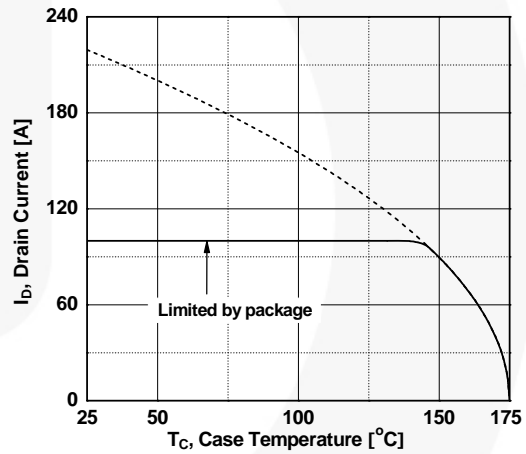
**Figure 8. On-Resistance Variation vs. Temperature**



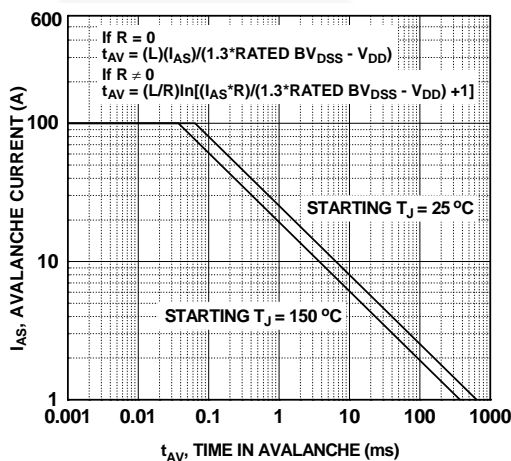
**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**

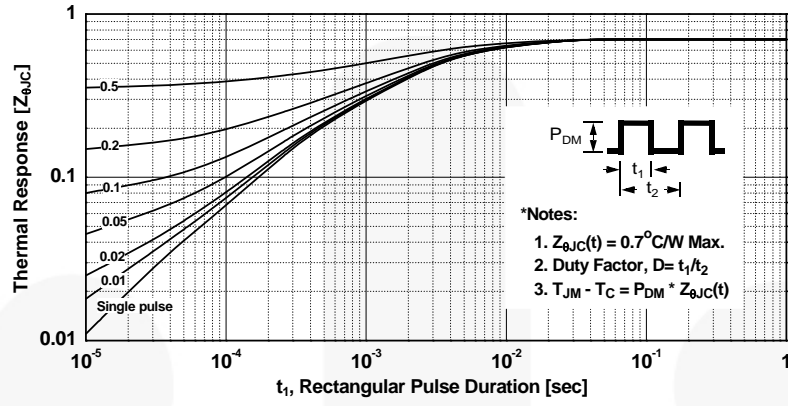


**Figure 11. Unclamped Inductive Switching Capability**

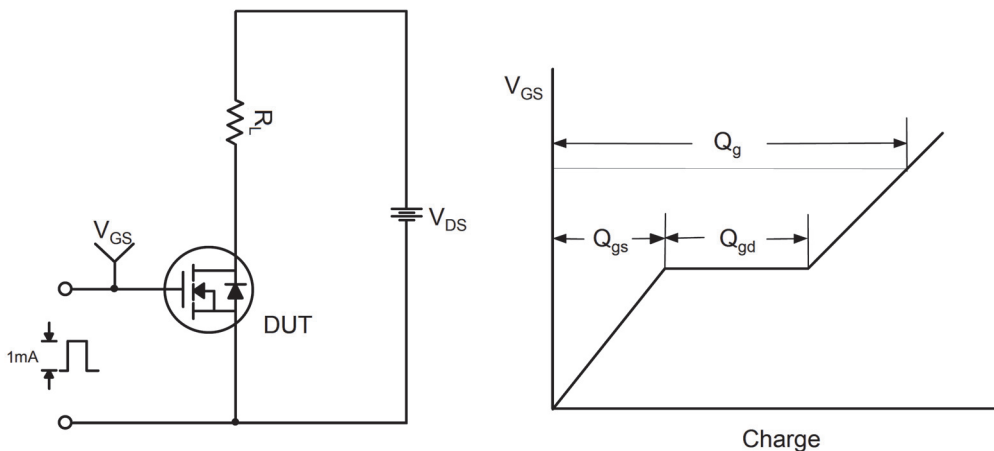


Typical Performance Characteristics (Continued)

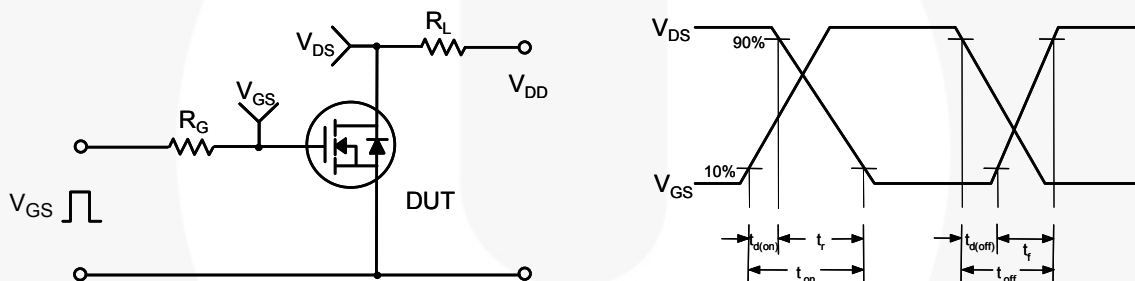
Figure 12. Transient Thermal Response Curve



**Figure 13. Gate Charge Test Circuit & Waveform**



**Figure 14. Resistive Switching Test Circuit & Waveforms**



**Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms**

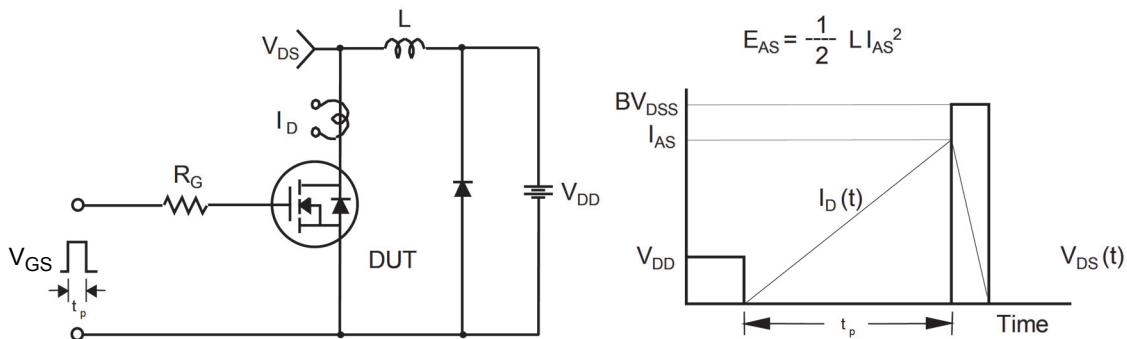
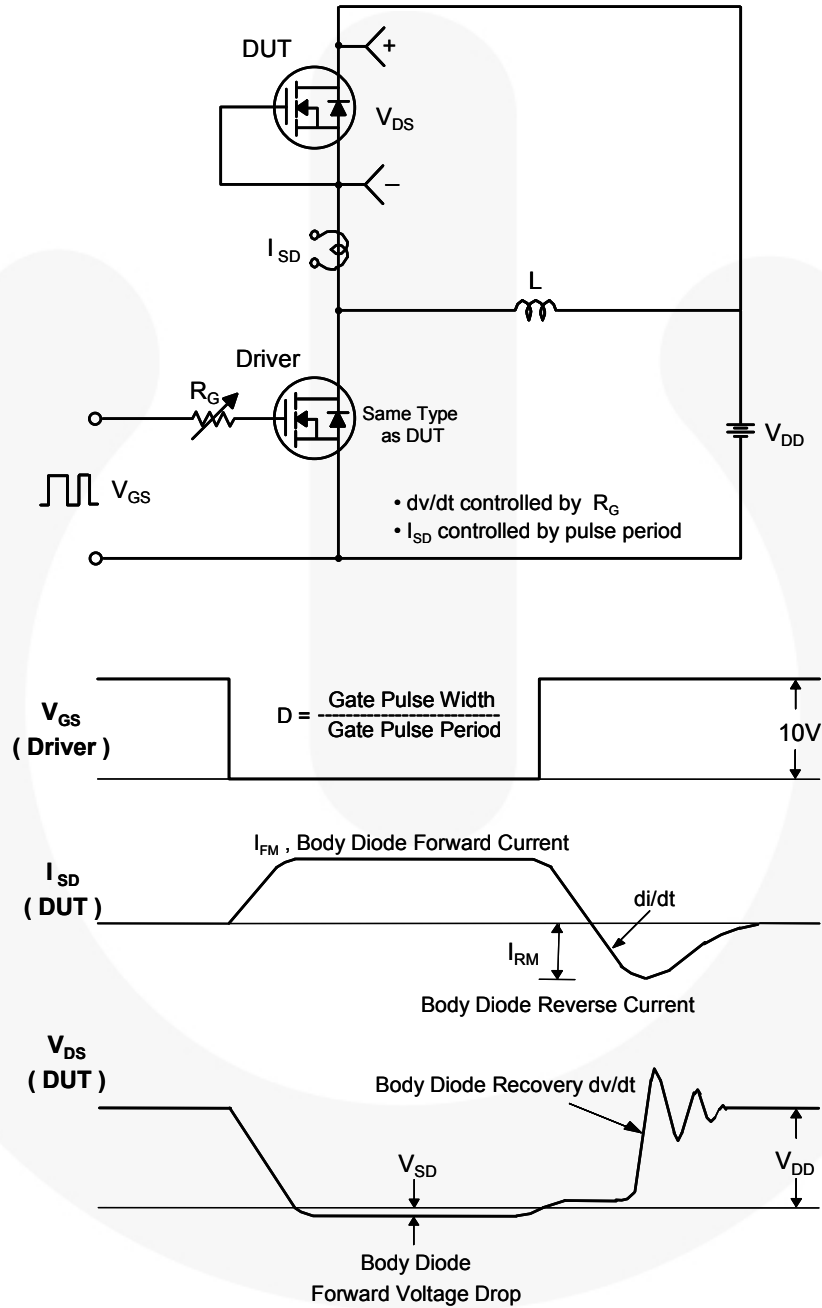
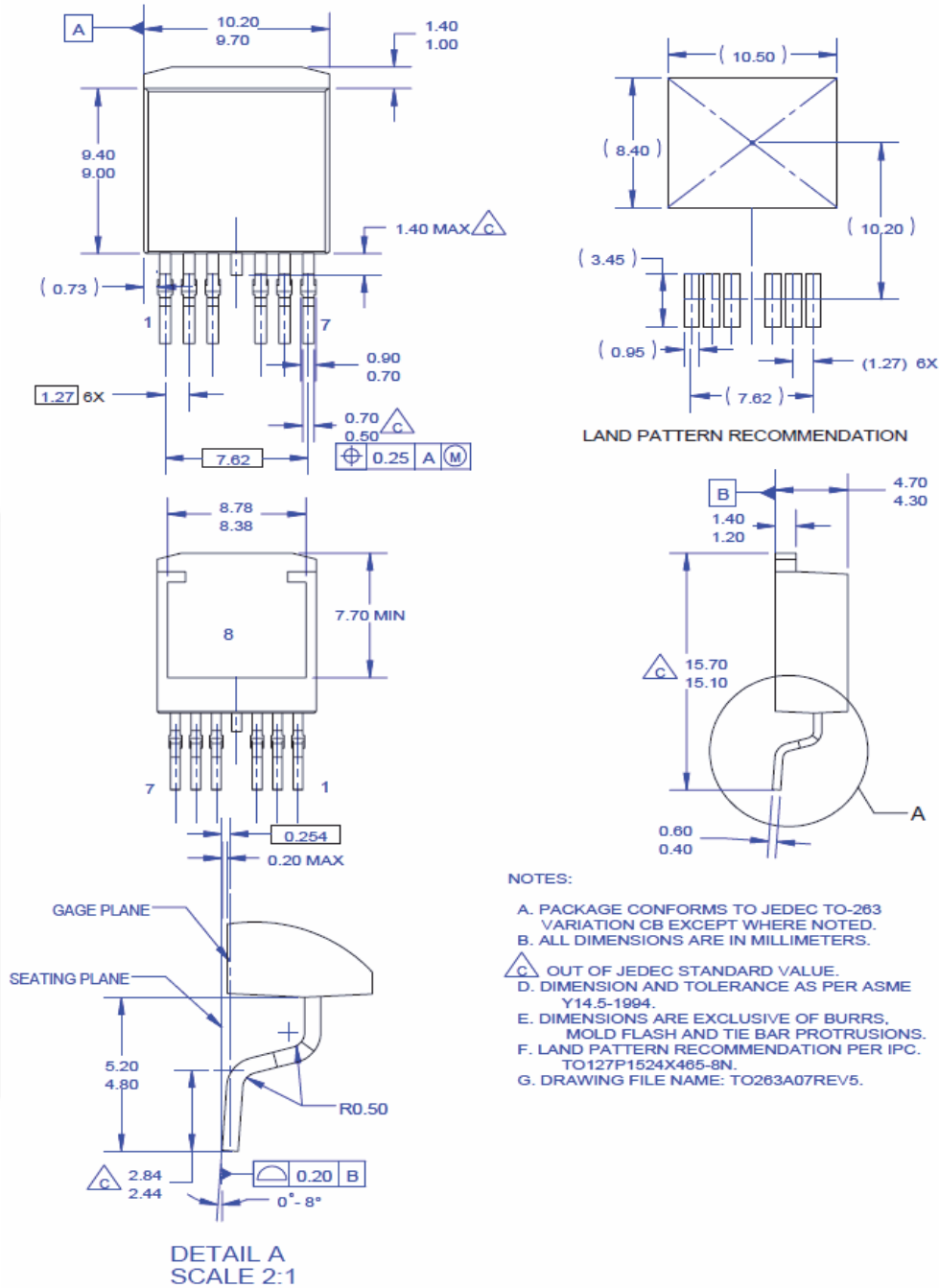


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms





## Mechanical Dimensions



**Figure 17. TO263 (D<sup>2</sup>PAK), Molded, 7-Lead, Surface Mount**

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[FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE221](#) [NTE222](#) [NTE2384](#) [NTE2903](#) [NTE2941](#) [NTE2945](#) [NTE2946](#) [NTE2960](#)  
[NTE2967](#) [NTE2969](#) [NTE2976](#) [NTE455](#) [NTE6400A](#) [NTE2910](#) [NTE2916](#) [NTE2956](#) [NTE2911](#) [DMN2080UCB4-7](#) [TK10A80W,S4X\(S](#)  
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